# SanRex<sub>®</sub>

### **TRIAC For High Power**

## **TG40E60**

I<sub>T(RMS)</sub> =40A, V<sub>DRM</sub>=600V

**T1** 

SanRex Triac TG40E60 is specially designed use for high power AC switching application. Thanks to SanRex's new isolated diffusion technology, the Triac TG40E60 features high dv/dt, dv/dt/c and very low on-state voltage. These benefits make this design an extremely reliable and efficient device for use in wide variety of applications.

#### **Features**

- \* High Power
- \* High Surge Current
- \* Low On-State Voltage
- \* High Commutation Performance
- \* UL registered E76102

#### **Typical Applications**

- \* Home Appliances
- \* Water Heaters
- \* Heater Controls
- \* Lighting Controls
- \* Temperature Controls

Isolated Fast-on Package
T1 OG T2

**T2** 

Gate

Internal schematic diagram

Maximum	n Ratings>		(Tj = 25°C unless otl	nerwise note
Symbol	Item	Conditions	Ratings	Unit
V <sub>DRM</sub>	Repetitive Peak Off-state Voltage		600	V
I <sub>T(RMS)</sub>	R.M.S. On-state Current	$T_{C} = 64^{\circ}C$	40	А
I <sub>TSM</sub>	Surge On-state Current	One cycle, 60Hz, Peak, non-repetitive	420	Α
l <sup>2</sup> t	I <sup>2</sup> t (for fusing)	Value for one cycle surge current	730	A <sup>2</sup> s
P <sub>GM</sub>	Peak Gate Power Dissipation		10	W
P <sub>G(AV)</sub>	Average Gate Power Dissipation		1	W
I <sub>GM</sub>	Peak Gate Current		3	А
V <sub>G M</sub>	Peak Gate Voltage		10	V
di/dt	Critical Rate of Rise of On-State Current	$I_G = 100$ mA, $V_D = 1/2V_{DRM}$ , $di_G/dt = 1A/\mu s$	50	A/F s
Tj	Operation Junction Temperature		-40 to +125	°C
Tstg	Storage Temperature		-40 to +150	°C
V <sub>ISO</sub>	Isolation Breakdown Voltage	R.M.S., A.C. 1 minute	2500	V
	Mounting Torque (M4)	Recommended value 1.0 – 1.4 N*m	1.5	N*m
	Mass	Typical Value	23	g

### **TRIAC** for High Power

### TG40E60

< Electrical Characteristics >

(Tj= 25°C unless otherwise noted)

Symbol	ltom	Conditions	Ratings			Linit	
Symbol		Item Conditions	Min.	Тур.	Max.	Unit	
I <sub>DRM</sub>	Repetitive Peak Off-state Current		$T_{i} = 125^{\circ}C, V_{D} = V_{DRM}$			5	mA
$V_{TM}$	Peak On-State Voltage		I <sub>T</sub> =60A, Instant measurement			1.4	V
I <sub>GT</sub> 1⁺	QI	Gate Trigger Current	$V_{D} = 6V, I_{T} = 1A$			50	mA
I <sub>GT</sub> 1	QII					50	mA
I <sub>GT</sub> 3⁺	QIV					-	mA
I <sub>GT</sub> 3 <sup>-</sup>	QIII					50	mA
$V_{GT}1^+$	QI	Gate Trigger Voltage	V <sub>D</sub> = 6V, I <sub>T</sub> =1A			1.5	V
$V_{GT}1^{-}$	QII					1.5	V
V <sub>G T</sub> 3⁺	QIV					-	V
V <sub>G T</sub> 3 <sup>-</sup>	QIII					1.5	V
$V_{G D}$	Non-Trigger Gate Voltage		$Tj = 125^{\circ}C, V_{D}=1/2V_{DRM}$	0.2			V
dv/dt	Critical Rate of Rise of Off-State Voltage		Tj = 125°C, V <sub>D</sub> =1/2V <sub>DRM</sub> , Exponential wave	500			V/Fs
(dv/dt)c	Critical Rate of Rise of Commutation Voltage		Tj =125°C, V <sub>D</sub> =2/3V <sub>DRM</sub> , (di/dt)c= 10 A/ms	6			V/Fs
Iн	Holding Current				30		mA
Rth(j-c)	Thermal Resistance		Junction to case			1.3	°C/W



G:TAB187 (T-4.75, T-5.7, t-0.8)

\* Dimensions in millimeters